Serial No. 10/615,432 Response dated July 23, 2004 Reply to Office Action of May 4, 2004

## IN THE ABSTRACT

Please amend the abstract of the disclosure as follows:

A radiator system includes a high-temperature body being a thermal source, a receiver with the high-temperature body boarded thereon, and a thermal buffer. The receiver receives heat from the high-temperature body. The thermal buffer is interposed at least between the high-temperature body and the receiver to buffer buffering thermal transmission from the high-temperature body to the receiver, includes a high thermal conductor and a low expander disposed at a position facing the high-temperature body and buried in the high thermal conductor, and has a first bonding area with respect to the high-temperature body and a second bonding area, larger than the first, with respect to the receiver. The second bonding area is enlarged greater than the first bonding area. The heat from the high-temperature body is radiated by the receiver or is radiated by way of the receiver. Thus, the thermal expansion difference can be minimized between the high-temperature body and receiver.